

DESC FORM 193
SEP 87
DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:

<u>5962-88710</u>	<u>01</u>	<u>R</u>	<u>X</u>
Drawing number	Device type (1.2.1)	Case outline (1.2.2)	Lead finish per MIL-M-38510

1.2.1 Device type. The device type shall identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	54F518	8-bit identity comparator with open-collector outputs and pull-up resistors on Q inputs

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

<u>Outline letter</u>	<u>Case outline</u>
R	D-8 (20-lead, 1.060" x .310" x .200"), dual-in-line package
S	F-9 (20-lead, .540" x .300" x .100"), flat package
2	C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package

1.3 Absolute maximum ratings.

Supply voltage range -0.5 V dc minimum to +7.0 V dc maximum
Input voltage range -1.2 V at -18 mA to +7.0 V dc
Input current range -30 mA to 5.0 mA
Voltage applied to any output in the high state -0.5 V dc to 5.5 V dc
Current into any output in the low state 40 mA
Storage temperature range -65° C to +150° C
Maximum power dissipation (P_D) 1/ 214.5 mW
Lead temperature (soldering, 10 seconds) +300° C
Thermal resistance, junction-to-case (Θ_{JC}) See MIL-M-38510, appendix C
Junction temperature(T_J) +175° C

1.4 Recommended operating conditions.

Supply voltage range (V_{CC}) +4.5 V minimum to +5.5 V maximum
Minimum high level input voltage (V_{IH}) 2.0 V dc
Maximum low level input voltage (V_{IL}) 0.8 V dc
Maximum high level output voltage (V_{OH}) 5.5 V dc
Maximum low level output current (I_{OL}) 20 mA
Case operating temperature range (T_C) -55° C to +125° C

1/ Maximum power dissipation, P_D , is defined as $V_{CC} \times I_{CC}$.

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth table. The truth table shall be as specified on figure 2.

3.2.3 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figure 3.

3.2.4 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ -55°C ≤ T _C ≤ +125°C unless otherwise specified	Group A subgroups	Limits		Unit
				Min	Max	
High level output current	I _{OH}	V _{CC} = 4.5 V V _{IL} = 0.8 V, V _{IH} = 2.0 V	1, 2, 3		0.1	mA
Low level output voltage	V _{OL}	V _{CC} = 4.5 V V _{IL} = 0.8 V, V _{IH} = 2.0 V	1, 2, 3		0.5	V
Input clamp voltage	V _{IC}	V _{CC} = 4.5 V I _{IN} = -18 mA	1, 2, 3		-1.2	V
Low level input current	I _{IL}	V _{CC} = 5.5 V V _{IN} = 0.5 V Unused inputs = 4.5 V	G and P inputs		-0.6	mA
			Q inputs		-1.0	
High level input current	I _{IH1}	V _{CC} = 5.5 V V _{IN} = 2.7 V Unused inputs = 0.0 V	G and P inputs		20	μA
			Q inputs		-0.3	mA
	I _{IH2}	V _{CC} = 5.5 V Unused inputs = 0.0 V	V _{IN} = 7 V G and P inputs		0.1	mA
			V _{IN} = 5.5 V Q inputs		0.1	
Supply current	I _{CC}	V _{CC} = 5.5 V V _{IN} = 4.5 V (All inputs)	1, 2, 3		39	mA
Functional tests		See 4.3.1c 3/	7, 8			
Propagation delay time, P or Q to P = Q	t _{PLH}	V _{CC} = 4.5 V to 5.5 V C _L = 50 pF R _L = 500Ω See figure 3 4/	9, 10, 11	4	15.5	ns
	t _{PHL}		9, 10, 11	2	11.5	ns
Propagation delay time, G to P = Q	t _{PLH}		9, 10, 11	4.5	15.5	ns
	t _{PHL}		9, 10, 11	2	9.5	ns

See footnotes on next page.

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- 1/ Unused inputs that do not directly control the pin under test must be $\geq 2.5\text{ V}$ or $\leq 0.5\text{ V}$, and shall not exceed 5.5 V or go less than 0.0 V . No inputs shall be floated.
- 2/ In the case where only one input at V_{IL} maximum or V_{IH} minimum produces the proper output state, the test must be performed with each input being selected as the V_{IL} maximum or V_{IH} minimum input.
- 3/ Functional tests shall be conducted at input test conditions of $GND \leq V_{IL} \leq V_{OL}$ and $V_{OH} \leq V_{IH} \leq V_{CC}$.
- 4/ Propagation delay limits are based on single output switching. Unused inputs = 0.0 V or 3.0 V .

3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A or D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2) $T_A = +125^\circ\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

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Case outlines	R, S, and 2
Terminal number	Terminal symbol
1	\bar{G}
2	P0
3	Q0
4	P1
5	Q1
6	P2
7	Q2
8	P3
9	Q3
10	GND
11	P4
12	Q4
13	P5
14	Q5
15	P6
16	Q6
17	P7
18	Q7
19	P = Q
20	V _{CC}

FIGURE 1. Terminal connections.

Inputs		Output
Data P, Q	Enable G	P = Q
P = Q	L	H
P \neq Q	X	L
X	H	L

H = High level voltage

L = Low level voltage

X = Irrelevant

FIGURE 2. Truth table.

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4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroups 7 and 8 tests shall verify the truth table as specified on figure 2 herein.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test, method 1005 of MIL-STD-883.
 - (1) Test condition A or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^\circ\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

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6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

6.4 Approved source of supply. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1/</u>
5962-8871001RX	01295	SNJ54F518J
5962-8871001SX	01295	SNJ54F518W
5962-88710012X	01295	SNJ54F518FK

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

01295

Vendor name
and address

Texas Instruments, Incorporated
P.O. Box 6448
Midland, TX 79711

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